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16-CHARACTER 2-LINE DOT MATRIX LCD CONTROLLER DRIVER

■ GENERAL DESCRIPTION

The NJU6420B is a 1 Chip Dot Matrix LCD controller driver for up to 16-character 2-line display.

It contains voltage converter, bleeder resistance, CR escillator, microprocessor interface circuits, instruction decoder controller, character generator ROM/RAM and high voltage operation common and segment drivers.

The voltage converter and bleeder resistance generates about twofold voltage(10V or 6V) and bias voltage for LCD driving waveform internally from single power supply (5V or 3V).

Consequently, high-contrast display can be performed though the simple power supply circuits.

The resistance and capacitance for CR oscillation circuits are incorporated, therefore no external components for the oscillation circuits are required.

The microprocessor interface circuits which operate by 2Mtz frequency, can be connected directly to 4/8bit microprocessor.

The character generator consists of 9,600bits ROM and 64 bytes RAM. The standard version ROM is coded with 240 characters including capital and small letter fonts and some of Japanese fonts.

The high voltage operation 32-common and 40-segment drivers operate up to 13.5V or 12V, and drive up to 16-character 2-line LCD panels which divided four common electrode blocks.

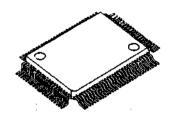
FEATURES

- 16-character 2-line Dot Matrix LCD Controller Driver
- 4/8 Bit Nicroprocessor Direct Interface
- Display Data RAM 80 x 8 bits : Maximum 16-character 2-line Display
- Character Generator ROM 9,600 bits: 240 Characters for 5 x 7 Dots
- Character Generator RAM 64 x 8 bits : 8 Patterns(5 x 7 Dots)
- Microprocessor can access to Display Data RAM and Character Generator RAM
- High Voltage LCD Driver: 32-common / 40-segment
- Programmable Duty Ratio: 1/16 Duty for 5x 7 Dots + Cursor, 1 Line
 1/32 Duty for 5x 7 Dots + Cursor, 2 Lines
- Number of Maximum Display Characters:

Display Line	Duty	Font	Max. Disp. Characters
1 Line	1/18 auty	5 x 7 dots + cursor	16-character 1-line
2 Lines		5 x 7 dots + cursor	16-character 2-line

- Useful Instruction Set : Clear Display, Return Home, Display ON/OFF Cont, Cursor ON/OFF Cont, Display Blink, Cursor Shift, Character Shift
- Power On Initialize Circuit On-chip
- Bleeder Resistance On-chip
- Voltage Converter On-chip
- Oscillation Circuit On-chip
- Low Power Consumption
- Operating Voltage --- 5 V / 3 V
- Package Outline --- Chip / QFP100
- C-MOS Technology

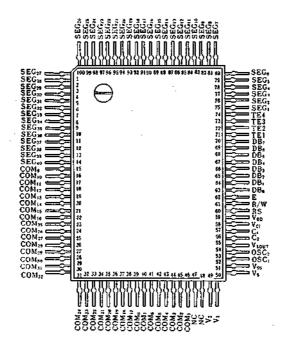
■ PACKAGE OUTLINE



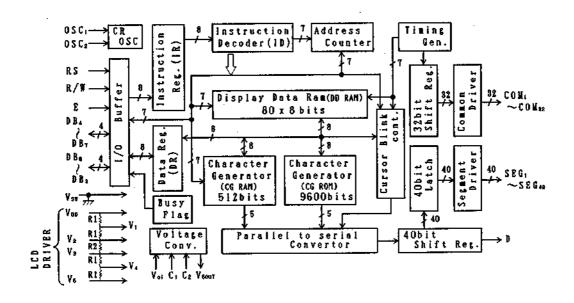
NJU6420F



PIN CONFIGURATION



■ BLOCK DIAGRAM





TERMINAL DESCRIPTION

NO.	SYMBOL	FUNCTION
59	Vpd	Power Source (+5V / +3V)
52	Vss	Power Source (0V)
53 54	OSC1 OSC2	Oscillation Frequency Adjust Terminals. Normally Open. (Oscillation C and R are incorporated, Osc Freq.=290kHz) For external clock operation, the clock should be input on OSC ₁ .
60	RS	Register selection signal input(Pull-up resistance On-chip) "O": Instruction Register (Writing) Busy Flag, Address Counter (Reading) "1": Data Register (Writing/Reading)
61	R/W	Read/Write selection signal input(Pull-up Resistance On-chip) "O": Write, "1": Read
62	E	Read/Write activation signal input
67~70	Ď8₄~DB7	3-state Data Bus(Upper) to transfer the data between MPU and NJU6420B. DB7 is also used for the Busy Flag reading.
63~66	D8₀~D8₃	3-state Data Bus(Lower) to transfer the data between MPU and NJU6420B. These bus are not used in the 4bit operation.
15~22 23~30 31~38 39~46	COM 9~COM16 COM25~COM32 COM24~COM17 COM 8~COM 1	LCD Common driving signal No use terminals output no-active signal, or COM ₁₇ ~COM ₅₂ output no-active signal.
75~100 1~14	SEG 1~SEG26 SEG27~SEG40	LCD Segment driving signal
57 56	C ₁	Capacitor for Voltage Doubler Connecting Terminal (+) Capacitor for Voltage Doubler Connecting Terminal (-)
58	Vei	Input Terminal for Voltage Doubler (Normally V _{c1} = V _{DD})
55	Vsout	Voltage Doubler Output Terminal
49,50,51	V ₂ , V ₃ , V ₅	LCD Driving Voltage Adjust Terminals
71~74	TE1~TE4	Maker Testing Terminals (Normally Open)
47,48	NC	Non Connection



■ FUNCTIONAL DESCRIPTION

(1) Description for each blocks

(1 − 1) Register

The NJU6420B incorporates two 8-bit registers, an Instruction Register(IR) and a Data Register(DR).

The Register(IR) stores instruction codes such as "Clear Display" and "Return Home", and address data for Display Data RAM(DD RAM) and Character Generator RAM(CG RAM).

The MPU can write the instruction code and address data to the Register(IR), but it cannot read out from the Register(IR).

The Register(DR) is a temporary stored register, the data stored in the Register(DR) is written into the DD RAM or CG RAM and read out from the DD RAM or CG RAM.

The data in the Register(DR) written by the MPU is transferred automatically to the DD RAM or CG RAM by internal operation.

When the address data for the DD RAM or CG RAM is written into the Register(IR), the addressed data in the DD RAM or CG RAM is transferred to the Register(DR). By the MPU read out the data in the Register(DR), the data transmitting process is performed completely.

After reading the data in the Register(DR) by the MPU, the next address data in the DD RAM or CG RAM is transferred automatically to the Register(DR) to provide for the next MPU reading.

These two registers are selected by the selection signal RS as shown below.

Table 1. shows register operation controlled by RS and R/W signals.

Table 1. Register Operation

RS	R/W	Selected Register	Operation
0	0	10	Mrite
0	1	IR "	Read busy flag(DB ₇) and address counter(DB ₀ ~DB ₆)
1	0	00	Write (Register(DR) to DD RAM or CG RAM)
1	1	DR	Read (DD RAM or CG RAM to Register(DR))

(1-2) Busy Flag (BF)

When the internal circuits are in the operation mode, the busy flag (BF) is "1", and any instruction reading is inhibited.

The busy flag (BF) is output at DB, when RS="0" and R/M="1" as shown in Table 1.

The next instruction should be written after the busy flag(BF) goes to "O".

(1-3) Address Counter (AC)

The address counter(AC) addressing the DD RAM and CG RAM.

When the address setting instruction is written into the Register(IR), the address information is transferred from Register(IR) to the Counter(AC). The selection of either the DD RAM or CG RAM is also determined by this instruction.

After writing (or reading) the display data to (or from) the DD RAM or CG RAM, the Counter (AC) increments (or decrements) automatically.

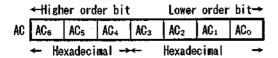
The address data in the Counter(AC) is output from DB₆ \sim DB₀ when RS="0" and R/W="1" as shown in Table 1.



(1-4) Display Data RAN (DD RAM)

The display data RAM (DD RAM) consists of 80 x 8 bits stores up to 80-character display data represented in 8-bit code.

The unused display data memory area in the DD RAM can be used as a general data memory area. The DD RAM address data set in the address counter(AC) is represented in Hexadecimal.



(Exam	ıple)	DĐ	RAN	addre	!\$ \$	<u>" 4</u>	E "	
1	0		0	1		1	1	0
← ––	· 4	_				-	E -	

(1-4-1) 16-character 1-line Display (Function set code N=0)

The relation between DD RAM address and display position on the LCD is shown below.

When the display shift is performed, the DD RAM address changes as follows:

(1-4-2) 16-character 2-line Display (Function set code №1)

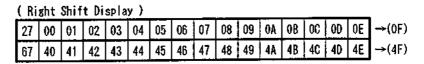
The relation between DD RAM address and display position on the LCD is shown below.

1.4	_1	2	3	4	5	6	_7	8	9	10	11	12	13	14	15	16	←Display
		01															
Zņa Line	40	41	42	43	44	45	46	47	48	49	4A	48	4C	4D	4E	4F	DD RAM Address ← (Hexadecimal)

Note: In the 2-line display mode, the 1st and 2nd line address are defined as $(00)_{\rm H}$ to $(27)_{\rm H}$ and $(40)_{\rm H}$ to $(67)_{\rm H}$. Please note that the end of 1st line address and the beginning of 2nd line address are not consecutive.

When the display shift is performed, the DD RAM address changes as follows:

(Left Shift Display) 00 0E 0F 10 02 | 03 07 08 09 OA. 0B OC. $(00) \leftarrow 01$ 05 | 06 50 (40)← 42 43 45 | 46 | 47 48 49 4A





(1-5) Character Generator ROM (CG ROM)

The Character Generator ROM(CG ROM) generates 5 x 7 dots character pattern represented in 8-bit character codes.

The storage capacity is up to 240 kinds of 5×7 dots character pattern.

The correspondence between character code and standard character pattern of NJU6420B is shown in Table 2-1 to 2-3.

User-defined character patterns (Custom Font) are also available by mask option.



Table 2-1. CG ROM Character Pattern (ROM version -01)

	<u></u>						U	pper 4	bit	(Hexa	adecin	mai)					
		0	1	2	3	4	5	6	7	8	9	A	В	С	D	E	F
	0	CG RAM (01)	-	·				••.	::: -				****		:::		#::
	1	{ 02 1		•				-===	-:::			:::	.;:		: <u>:</u>	:::	::4
	2	(03)		**					!· "·			:"		!!!	.∷:	::::	::: !
	3	104)		***			:;	1	·			:	!" <u>`</u> .			::·	::::
	4	(05)			:							٠.		! ··	1:		:::
	5	(06)		* .:			 !	1555	1!			::	::	<u>;</u>		:::	11
imal)	6	(07)				:	·•		١١			::;;	111				<u>::</u>
(Hexadecimal	7	(08)		:	· · · · ·	: :::3	******	!	i,:,i			:::	::::	;:: [;]		::::	.TI .
4 bit (8	(01)				: :			:::			.:	-:",		·.		;:: <u>:</u>
Lower	9	(02)				.i.			•!			::::	•";"		11.	:	·!
	A	(03)		:#:	:: ::		····	:	:::			::::	!	: `;			:::::
	В	(84)						! ::				::#	1.:	!		×	.:::
	С	(05)		::	••••							***	<u>::</u> .:		ŗ	::::	
	D	(06)		••••	*****			" "				.:		••••	·i	:	<u>:</u>
	E	(07)		::			.···.	l'"i	***			:::	1		•.*•		
	F	(08)			:		•••••	11	••••			:::	÷!	*:	I.:		



Table 2-2. CG ROM Character Pattern (ROM version -02)

						•	-										
							gqqU	er 4 b	it (texade	cimal)	ı				
L `		0	1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F
	0	CG RAM (01)						٠.	::: ·						***.		#::
	1	(02)		•	::.			-:::	-::::	1		:::		:::	i;	·:::i	-::-
	2	(03)		::					 .			:	•	11,1	.:: [†]	::::	
	3	(04)	:		:	 :	::::;	: <u></u> .	::::-	-:::		:	" .;		÷:::	:::.	::::
	4	(05)		***		::	****		₩.	::::		٠.		•	:::	 !	
mal)	5	(06)		÷.::	:	:	1	===	!!	::: !		::	1			::::	1
bit (Hexadecimal	6	(07)	::::	∴ ≍	<u>:::</u> :		I ,,!	1.	i.,i	::::		:::	•			<u>;::</u> :	:
4 bit (7	(08)		r.					1,.,1	:::-		·;;:	:::::::::::::::::::::::::::::::::::::::	;:: :			71.
Lower 4	8	(01)		•			:::	ļ.";	:::	::: :	•	.:]		·.!	.;"	.×.
	9	(02)	:;		;;;;	:	1	:	*!			11:31	.";		11:	-:	·•
	A	(03)	:	*	::	"	:::	.:				::::		1	ļ.·		:::::
	В	(04)	:	•	:		!	*:		1	:::	::	::			×	
	С	(05)	****	: •.	•:	i		1.	•	i	÷.	4::	::., !	1	::;i	::::	
	D	(06)	•	•••••	*****			l'i	•	1		.:1.	.::	•••		:	
	Е	(07)	·::	::			•••	l''1	•••			=======================================		::::	•••		
	F	(08)	:::			<u></u> i		::::	••••		.:	::1	٠١	::	:::		



Table 2-3. CG ROM Character Pattern (ROM version -03)

							Uı	pper 4	bit	(Hexa	decim	al)					
`		0	1	2	3	4	5	6	7	8	9	Α	В	С	D	E	F
	0	CG RAM (01)					:;	Υ.	!::: -	::::			•				
	1	(02)	*****	:	:			-:::1	-:::	1!	:		•	.!		`.;.·	1
	2	(03)	1,1	**	.:		! ::	;		::::		::::	•;•	::::		::::	-1:
	3	(04)	.: .	#		1		:	:::.	*:::	::::	• • •	•		******	:::	:
	4	(05)		::::	::.						:::::	#	•	#	•	•	(),)
	5	(06)	•		·:			: :::		-:::	:::		:::	**	:::	;***** :****	****
imal)	6	(07)	7.		:::::		I.,!		1.,.1	::::	1						!!!
(Hexadecimal	7	(08)		::			Ī.;.!	-:::	1,:,1	·	1		:::	:	1274	١	
4 bit (8	(01)	•	•.			;:: <u>;</u>	! ;	::::			*	•••••	-1;	•••••	k:	
Lower	9	(02)	•		***	***	1	:	·			•	::				#
	A	(03)	:::		## ##	!				:::::				*****		.	
	В	(04)	1		;;	! ::	! .,	! ::	:						: : :	1"	
	C	(05)	:::::	;:	•:	i	٠٠.			1		::: i	!			::	
	D	(06)	: : ;	****	•••••			ïïi		1.		:::	:::	ı		JII.	12121
	E	(07)	1::	::				1."1					!"				
	F	(08)			•		****		::::		:·		*****		::::	ı::T	



(1-6) Character Generator RAM (CG RAM)

The character generator RAM (CG RAM) can store any kind of character pattern in 5 x 7 dots written by the user program to display user's original character pattern. The CG RAM can store 8 kinds of characters in 5 x 7 dots mode.

To display user's original character pattern stored in the CG RAM, the address data (00) -(07) H or (08) H - (0F) H should be written to the DD RAM as shown in Table 2-1 to 2-3.

Table 3. show the correspondence among the character pattern, CG RAM address and Data. Unused memory area of the CG RAM can also be used as the general data memory area.

Table 3. Correspondence of CG RAM address, DD RAM character code and CG RAM character pattern (5 x 7 dots).

Character Code	CG RAM	Character Pattern	
(DD RAM Data)	Address	(CG RAM Data)	
76543210	543210	7.6543210	
Upperbit Lowerbit	Upper Lower	Upperbit Lowerbit	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 1 0 0 1 1 0 0 0 1 1 1 0 0 1 1 1 1 0 1	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character Pattern Example (1) -Cursor Position
0000 + 001	0 0 0 0 0 1 0 1 0 0 1 1 0 0 1 1 0 0 1 0 1 1 1 0	* * * 30 0 0 1	Character Pattern Example (2) ←Cursor Position
	000	* * *	
			_
0000*111	1 1 1 0 1 1 1 0 0 1 0 1 1 1 0 1 1 1	* * *	* : Don't Care

Notes: 1. Character code bit 0 to 2 correspond to the CG RAM add. 3 to 5(3bits:8 patterns).
2. CG RAM address 0 to 2 designate character pattern line position. The 8th line is

the cursor position and the display is performed by logical OR with cursor. Therefore, in case of the cursor display, the 8th line should be "O". If there is "1" in the 8th line, the bit "1" is always displayed on the cursor position regardless of cursor existence.

3. Character pattern row position correspond to the CG RAM data bits 0 to 4 are shown above. The bits 5 to 7 of the CG RAM are not appear on the display (no meaning for the display), but memory elements are existing, therefore it can be used as the general purpose RAM.

4. CG RAM character patterns are selected when character code bits 4 to 7 are all "0" and it is addressed by character code bits 0 to 2. Therefore, the address (00)_H and (08)_H, (01)_H and (09)_H, -------, (07)_H and (0F)_H select the same character pattern as shown in Table 2-1 to 2-3, and Table 3.

5. "1" for CG RAM data corresponds to display On and "0" to display Off.



(1-7) Timing Generator

The timing generator generates a timing signals for the DD RAM, CG RAM, CG ROM and other internal circuits operation.

RAM read timing for the display and internal operation timing for MPU access are separately generated, so that they may not interfere with each other.

Therefore, when the data write to the DD RAM for example, there will be no undesirable influence, such as flickering, in areas other than the display area.

(1-8) LCD Driver

LCD driver consist of 32-common driver and 40-segment driver.

When the line number is selected by a program, the required common drivers output the common driving waveform and the other common drivers output non-selection waveform automatically.

The 40 bits of character pattern data are shifted in the shift-register and latched when the 40 bits shift performed completely. This latched data controls display driver to output LCD driving waveform.

(1-9) Cursor Blinking Control Circuit

This circuits controls cursor On/Off and the cursor position character blinks.

The cursor or blinks appear in the digit residing at the DD RAM address set in the address counter (AC).

When the address counter is (08) H. a cursor position is shown as follows:

(Note) The cursor or blinks also appear when the address counter (AC) selects the CG RAM. But the displayed cursor and blink are meaningless.

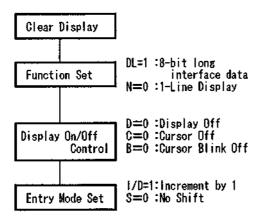
If the AC storing the CG RAM address data, the cursor and blink are displayed in the meaningless position.



(2) Power on Initialization by internal circuits

The NJU6420B is automatically initialized by internal power on initialization circuits when the power is turned on. In the internal power on initialization, following instructions are executed. During the Internal power on initialization, the busy flag (BF) is "1" and this status is kept 10 ms after V_{PP} rises to 4.5V.

Initialization flow is shown below:



NOTE

If the condition of power supply rise time described in the Electrical Characteristics is not satisfied, the internal Power On Initialization Circuits will not operate and initialization will not be performed.

In this case the initialization by MPU software is required.

(3) Instructions

The NJU6420B incorporates two registers, an Instruction Register (IR) and a Data Register (DR). These two registers store control information temporarily to allow interface between NJU6420B and MPU or peripheral ICs operating different cycles. The operation of NJU6420B is determined by this control signal from MPU. The control information includes register selection signals (RS), read/write signals (R/W) and data bus signals (DB₀ to DB₇).

Table 4, shows each instruction and its operating time.

Note) The execution time mentioned in Table 4. based on fcp or fosc=290kHz.

If the oscillation frequency is changed, the execution time is also changed.



Table 4. Table of Instructions

1 NSTRUCT 10NS	RS	R/W		DBs	O DBs	D DB4	E DB₃	DB ₂	DB ı	DBo	DESCRIPTION	EXEC Time
Non-operation	0	0	0	0	0	0	0	0	0	0	Non-operation. Only takes judge- ment machine cycle.	35us
Clear Display	0	0	0	0	0	0	0	0	0	1	Display clear and sets DD RAM address 0 in AC.	1.42ms
Return Home	0	0	0	0	0	0	0	0	1	*	Sets DD RAM address 0 in AC and returns display being shifted to original position. DD RAM contents remain unchanged	1.42ms
Entry Mode Set	0	0	0	0	0	0	0	1	1/0) S	Sets cursor move direction and specifies shift of display are performed in data read/write. [/D=1:Increment,]/D=0:Decrement S=1:Accompanies display shift	35us
Display On/Off Control	0	0	0	0	0	0	1	D	C	В	Sets of display On/Off(D), cursor On/Off(C) and blink of cursor position character(B).	35us
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	*	*	Moves cursor and shifts display without changing DD RAM contents S/C=1 : Display shift S/C=0 : Cursor shift R/L=1 : Shift to the right R/L=0 : Shift to the left	52us
Function Set	0	0	0	0	1	DL	. N	*	*	*	Sets interface data length(DL), number of display lines(N). DL=1 : 8 bits , DL=0 : 4 bits N=1 : 2 lines , N=0 : 1 line	35us
Set CG RAM Address	0	0	0	1	+		- Α	les	-	>	Sets CG RAM address. After this instruction, the data is transferred to/from CG RAM.	35us
Set DD RAM Address	0	0	1	*			App)	_	- >	Sets DD RAM address. After this instruction, the data is transferred to/from DD RAM.	35us
Read Busy Flag & Address	0	1	BF	+		•	AC		_		Reads busy flag and AC contents. BF=1 : Internally operating BF=0 : Can accept instruction	Ous
Write Data to CG & DD RAM	1	0	+		•	Wrif	te Da	ata	_	- →	Writes data into DD or CG RAMs.	35us
Read Data from CG or DD RAM	1	1	*		-	Read	d Dat	ta	_		Reads data from DD or CG RAMs.	52us
Explanation of Abbreviation	Acc	a : 1	og Ri	AM a	ddre	3S .	ADD	: D	D RA	M addr	racter generator RAM ess, Corresponds to cursor address and CG RAMs	



(3-1) Description of each instructions

(a) NOP (Non operation)

	RS	R/N	DB7	DBe	DB ₅	DB 4	DB₃	DB ₂	DB ₁	DBo
Code	0	0	Q.	0	0	0	0	0	0	0

Non operation instruction. It consumes certain judgement machine cycles only.

(b) Clear Display

	RS	R/W	DB7	DBs	DB ₅	Ð₿₄	DВз	DB ₂	DB ₁	DBo
Code	0	0	0	0	0	0	0	0	0	1

Clear display instruction is executed when the code "1" is written into DBo.

When this instruction is executed, the space code (20) is written into every DD RAM address, the DD RAM address 0 is set into the address counter and entry mode is set increment.

If the cursor or blink are displayed, they are returned to the left end of the LCD (the left end of the 1st line in the 2-line display mode).

The S of entry mode does not change.

Note: The character pattern for character code (20) must be blank code in the user-defined character pattern(Custom font).

(c) Return Home

	RS	R/W	DB7	DB ₆	DB ₅	DB4	DB₃	DB ₂	DB ₁	DB _o	
Code	0	0	0	0	0	0	0	0	1	*	* = Don't care

Return home instruction is executed when the code "1" is written into DB: When this instruction is executed, the DD RAM address 0 is set into the address counter. Display is returned its original position if shifted, the cursor or blink are returned to the left end of the LCD (the left end of the 1st line in the 2-line display mode) if the cursor or blink are on the display.

The DD RAM contents do not change.



(d) Entry Mode Set

	RS	R/W	D B 7	DB^e	DB ₅	DB₄	DB₃	DB ₂	DB 1	DBo
Code	0	0	0	0	0	0	0	1	1/0	S

Entry mode set instruction which sets the cursor moving direction and display shift On/Off, is executed when the code "1" is written into DB_2 and the codes of (I/D) and (S) are written into $DB_1(I/D)$ and $DB_0(S)$, as shown below.

(I/D) sets the address increment or decrement, and the (S) sets the entire display shift in the DD RAM writing.

I/D	Function
1	Address increment: The address of the DD RAM or CG RAM increment (+1) when the read/write, and the cursor or blink move to the right.
0	Address decrement: The address of the DD RAM or CG RAM decrement (-1) when the read/write, and the cursor or blink move to the left.
S	Function
s t	Entire display shift. The shift direction is determined by I/D.: shift to the left at I/D=1 and shift to the right at the I/D=0. The shift is operated only for the character, so that it looks as if the cursor stands still and the display moves. The display does not shift when reading from the DD RAM and writing/reading into/from CG RAM.

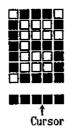


(e) Display On/Off Control

	RS	R/W	DB ₇	DBe	DBs	DB₄	DB3	082	DB,	DBo
Code	0	0	0	0	0	0	1	D	C	В

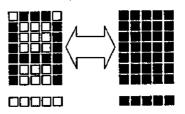
Display On/Off control instruction which controls the whole display On/Off, the cursor On/Off and the cursor position character blink, is executed when the code "1" is written into DB_3 and the codes of (D), (C) and (B) are written into $DB_2(D)$, $DB_1(C)$ and $DB_0(B)$, as shown below.

D	Function
1	Display On.
0	Display Off. In this mode, the display data remains in the DD RAM so that it is retrieved immediately on the display when the D change to 1.
C	Function
1	Cursor On. The cursor is displayed by 5 dots on the 8th line.
0	Cursor Off. Even if the display data write, the I/D etc does not change.
В	Function
1	The cursor position character is blinking. Blinking rate is 488.9ms at for =290kHz. The blink is displayed alternatively with all on (it means all black) and character display. The cursor and the blink can be displayed simultaneously.
0	The character does not blink.



Character Font 5 x 7 dots

(1) Cursor display example



Alternating display

(2) Blink display example



(f) Cursor/Display Shift

	RS	R/₩	DB7	DBe	DB ₅	DB4	DB₃	DB_2	DB ₁	DBo	
Code	0	0	0	0	0	1	S/C	R/L	*	*	* = Don't care

The Cursor/Display shift instruction shifts the cursor position or display to the right or left without writing or reading display data. This function is used to correct or search the display. In the 2-line display, the cursor moves to the 2nd line when it passes the 40th digit of the 1st line. Notice that the 1st and 2nd line displays will shift at the same time. When the displayed data is shifted repeatedly, each line moves only horizontally.

The 2nd line display does not shift into the 1st line position.

The contents of address counter(AC) does not change by operation of the display shift only. This instruction is executed when the code "1" is written into DB₄ and the codes of (S/C) and (R/L) are written into DB₃(S/C) and DB₂(R/L), as shown below.

S/C	R/L	Function
0	0	Shifts the cursor position to the left ((AC) is decremented by 1) Shifts the cursor position to the right ((AC) is incremented by 1) Shifts the entire display to the left and the cursor follows it. Shifts the entire display to the right and the cursor follows it.

(g) Function Set

	RS	R/W	DB 7	DB^e	DBs	DB₄	DB₃	DB2	DB ₁	DBo	-
Code	0	0	0	0	1	DL	N	*	*	*	∗ = Don't care

Function set instruction which sets the interface data length and number of display lines, is executed when the code "1" is written into DB₅ and the codes of (DL) and (N) are written into DB₄(DL) and DB₃(N)), as shown below (character font is fixed 5 x 7 dots).

(DL) sets the interface data length and (N) sets the number of display lines either the 1-line or 2-line.

This function set instruction must be performed at the head of the program prior to all other existing instructions(except Busy flag/Address read). This function set instruction can not be executed afterwards unless the interface data length change.

DL	Function
1	Set the interface data length to 8-bit (DB7 to DB0)
0	Set the interface data length to 4-bit (DB, to DB4) The data must be sent or received twice in this mode.

N	Display lines	Character Font	Duty ratio	Note
0	1	5 x 7 dots	1/16	
1	2	5 x 7 dots	1/32	



(h) Set CG RAM Address

Set CG RAM address set instruction is executed when the code "1" is written into DB_6 and the address is written into DB_5 to DB_6 as shown above.

The address data mentioned by binary code "AAAAAA " is written into the address counter (AC) together with the CG RAM addressing condition. After this instruction execution, the data writing/reading is performed into/from the CG RAM.

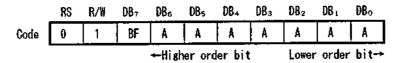
(i) Set DD RAM Address

Set DD RAM address instruction is executed when the code "1" is written into DB_7 and the address is written into DB_6 to DB_0 as shown above.

The address data mentioned by binary code "AAAAAAA " is written into the address counter (AC) together with the DD RAM addressing condition. After this instruction execution, the data writing/reading is performed into/from the DD RAM.

Note: In case of the 1-line display, the address data is $(00)_H$ to $(4F)_H$, and during the 2-line display, the address is $(00)_H$ to $(27)_H$ for the 1st line and $(40)_H$ to $(67)_H$ for the 2nd line.

(i) Read Busy Flag & Address



This instruction reads out the internal status of the NJU6420B. When this instruction is executed, the busy flag (BF) which indicate internal operation is read out from DB $_7$ and the address of the CG RAM or DD RAM is read out from DB $_6$ to DB $_0$ (the address for the CG RAM or DD RAM is determined by the previous instruction).

(BF)="1" indicates that internal operation is in progress. The next instruction is inhibited when (BF)="1". Check the (BF) status before the next write operation.



(k) Write Data to CG RAM or DD RAM

	RS	R/W	DB 7	DB_6	DBs	DB ₄	DB₃	DB_2	DB 1	DBo	_
Code	1	0	D	D	D	D	D	D	D	D	
•			←-l ligi	ner or	der bit	t		Lower	r orde	r bit→	

Write Data to CG RAM or DD RAM instruction is executed when the code "1" is written into (RS) and code "0" is written into (R/W).

By the execution of this instruction, the binary 8 bit data "DDDDDDDDD" are written into the CG RAM or DD RAM. The selection of the CG RAM or DD RAM is determined by the previous instruction. After this instruction execution, the address increment(+1) or decrement (-1) is performed automatically according to the entry mode set. And the display shift is also executed according to the previous entry mode set.

(1) Read Data from CG RAM or DD RAM

	RS	R/W	DB7	D₿¢	DB_5	DB4	DВз	DB2	DB 1	DBo	_
Code	1	1	D	D	D	D	Đ	D	D	D]
	←Higher order bit								r orde	r bit→	•

Read Data from CG RAM or DD RAM instruction is executed when the code "1" is written into (RS) and (R/W).

By the execution of this instruction, the binary 8 bit data "DDDDDDDD" are read out from the CG RAM or DD RAM. The selection of the CG RAM or DD RAM is determined by the previous instruction.

Before executing this instruction. either the CG RAM address set or DD RAM address set must be executed, otherwise the first read out data are invalidated.

When this instruction is serially executed, the next address data is normally read from the second read.

The address set instruction is not required if the cursor shift instruction is executed just beforehand (only DD RAM reading).

The cursor shift instruction has same function as the DD RAM address set, so that after reading the DD RAM, the address increment or decrement is executed automatically according to the entry mode.

But display shift does not occur regardless of the entry mode.

Note: The address counter(AC) is automatically incremented or decremented by 1 after write instruction to either of the CG RAM or DD RAM. Even if the read instruction is executed after this instruction, the addressed data can not be read out correctly. For a correct data read out, either the address set instruction or cursor shift instruction (only with DD RAM) must be implemented just before this instruction or from the second time read out instruction execution if the read out instruction is executed 2 times consecutively.

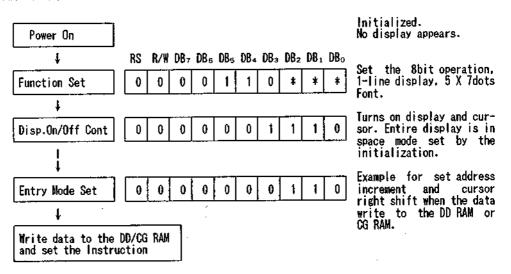


(3-2) Initialization using the internal reset circuits

(a) 16-character 1-line display in 8-bit operation (Using internal reset circuits).

At the 16-character 1-line display, the Function set, Display On/Off Control and Entry Set Instruction must be executed before the data input, as shown below.

The DD RAM of the NJU6420B can store up to 80 characters, as explained before, therefore the advertising moving display is available when combined with the display shift operation. Since the display shift operation changes only display position and the DD RAM contents remain unchanged, display data which are entered first can be output when the return home operation is performed.



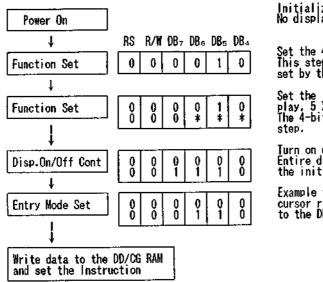
(b) 16-character 1-line in 4-bit operation (Using internal reset circuits).

In the 4-bit operation, the function set must be performed by the user programming.

When the power is turned on, 8-bit operation is selected automatically, therefore the first input is performed under 8-bit operation. In this operation, full instruction can not input because of terminals DB_0 to DB_3 are no connection. Therefore, same instruction must be rewritten on the RS, R/W and DB_7 to DB_4 , as shown below. Since one operation is completed by the two accesses in the 4-bit operation mode, rewrite is required to set the instruction code in full.

16-character 1-line in 4-bit operation is shown as follows:





Initialized. No display appears.

Set the 4-bit operation. This step is executed in 8-bit mode set by the initialization.

Set the 4-bit operation, 1-line display, 5 X 7dots Font. The 4-bit operation starts from this step.

Turn on display and cursor. Entire display is in space mode set by the initialization.

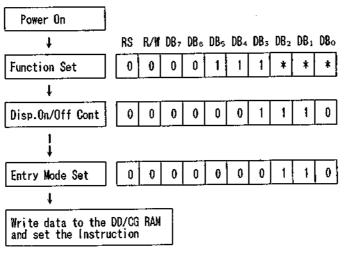
Example for set address increment and cursor right shift when the data write to the DD RAM or CG RAM.

(c) 16-character 2-line in 8-bit operation (Using internal reset circuits).

In the 2-line display, the cursor moves automatically from the 1st to the 2nd line after the 40th character of the first line has been written. Therefore, if the display character is only 16 characters in the 1st line, the DD RAM address must be set by the user programing to change the cursor position to the 2nd line.

The 1st and 2nd line displays will shift at the same time.

When the displayed data is shifted repeatedly, each line moves only horizontally. The 2nd line display does not shift into the 1st line position.



Initialized. No display appears.

Set the 8-bit operation, 2-line display, 5 X 7dots Font.

Turns on display and cursor. Entire display is in space mode set by the initialization.

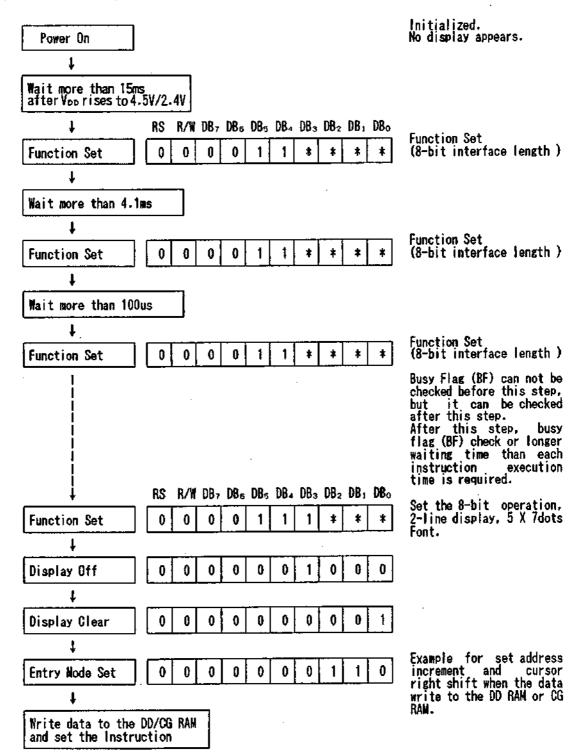
Example for set address increment and cursor right shift when the data write to the DD or CG RAM.



(3-3) Initialization by instruction

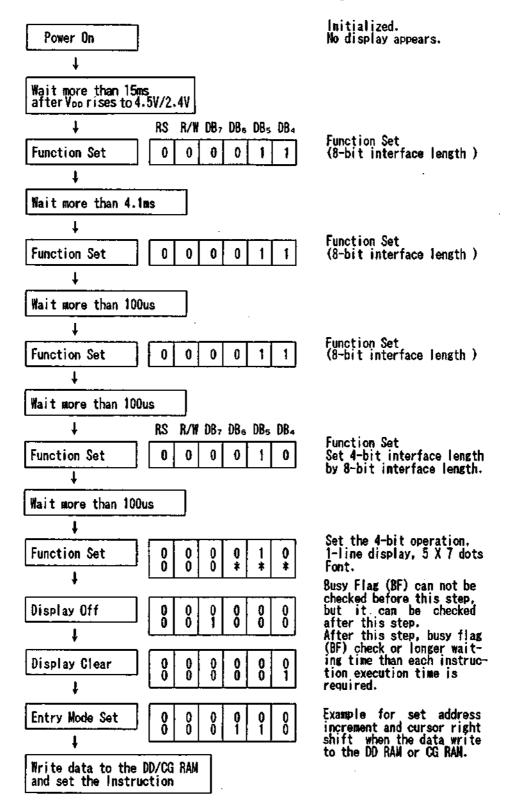
If the power supply conditions for the correct operation of the internal reset circuits are not met, the NJU6420B must be initialized by the instruction.

(a) Initialization by Instruction in 8-bit interface length.





(b) Initialization by Instruction in 4-bit interface length





(4) LCD DISPLAY

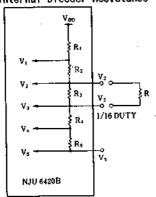
(4-1) Power Supply for LCD Driving

NJU6420B incorporate voltage doubler to generate LCD driving high voltage and bleeder resistance. The voltage doubler generate about twofold voltage from the $V_{\rm C1}$ input voltage (9.5V typ at lout=2mA and $V_{\rm C1}$ =5V) and bleeder resistance generate each LCD driving voltage. The bleeder resistance is set 1/6.7 bias suitable for 1/32 duty ratio and each resistance value are 1k Ω typ for R_1 , R_2 , R_4 and R_5 , and 2.7k Ω typ for R_3 .

Furthermore, the both ends of resistance R_3 have each terminals to change the bias level to 1/5 suitable for 1/16 duty ratio by connecting external resistance.

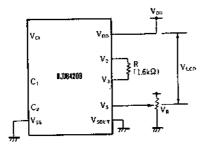
When LCD drives by only 5V (logic operating voltage), open the terminals C_1 , C_2 and connect the V_{SOUT} to the V_{SS} . In this time brightness must be adjusted by using the V_{S} terminal.

Internal Bleeder Resistance

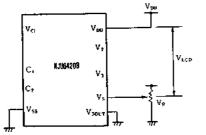


LCD Driving Voltage vs Duty Ratio

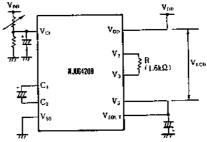
Power supply	Duty Ratio	1/32	1/16
SUPPLY	Bias	1/6.7	1/5
	External R	No	1.6kΩ
٧	5	V _{DD} t	о Уьсь



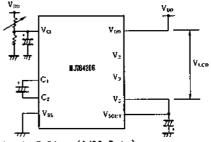
(a) 1/5 Bias (1/16 Duty) (Internal Voltage Doubler No-use Example)



(c) 1/6.7 Bias (1/32 Duty) (Internal Voltage Doubler No-use Example)



(b) 1/5 Bias (1/16 Duty) (Internal Voltage Doubler Using Example)



(d) 1/6.7 Bias (1/32 Duty) (Internal Voltage Doubler Using Example)



(4-2) Relation between oscillation frequency and LCD frame frequency.

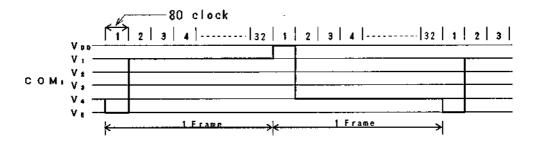
As the NJU6420B incorporates oscillation capacitor and resistor for CR oscillation, 290kHz oscillation is available without any external components.

In case of the high frequency operation, it is available by connecting external resistance between OSC1 and OSC2.

The LCD frame frequency example mentioned below is based on 290kHz oscillation.

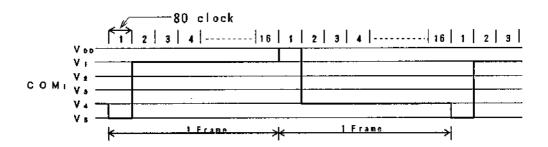
(1 clock = 3.4 us)

(a) 1/32 duty



1 frame = $3.4(us) \times 80 \times 32 = 8.704(us) = 8.704(ms)$ Frame frequency = 1/8.704(ms) = 115(Hz)

(b) 1/16 duty



1 frame = $3.4(us) \times 80 \times 16 = 4.352(us) = 4.352(ms)$ Frame frequency = 1/4.352(ms) = 229(Hz)



(5) Interface with MPU

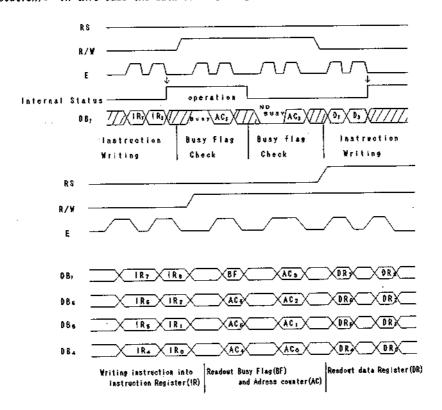
NJU6420B can be interfaced with both of 4/8 bits MPU and the two-time 4-bit or one-time 8-bit data transfer is available.

(5-1) 4-bit MPU interface

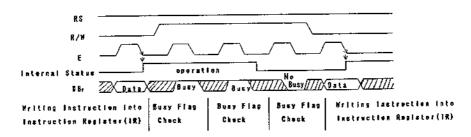
When the interface length is 4-bit, the data transfer is performed by 4 lines connected to DB_4 to DB_7 (DB_0 to DB_3 are not used). The data transfer with the MPU is completed by the two-time 4-bit data transfer.

The data transfer is executed in the sequence of upper 4-bit (the data DB₄ to DB₇ at 8-bit length) and lower 4-bit (the data DB₆ to DB₈ at 8-bit length).

The busy flag check must be executed after two-time 4-bit data transfer (1 instruction execution). In this case the data of busy flag and address counter are also output twice.



(5-2) 8-bit MPU interface





■ ABSOLUTE MAXIMUM RATINGS

(Ta=25℃)

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage (1)	Vod	- 0.3 ~ + 7.0	٧
Supply Voltage (2)	V₁ ~ V₅	Von-13.5 ~ Von+0.3	٧
Input Voltage	Vin	- 0.3 ~ Vpb+0.3	٧
Operating Temperature	Topr	- 30 ~ + 80	*C
Storage Temperature	Tstg	- 55 ~ + 125	°C

Note 1) If the LSI are used on condition above the absolute maximum ratings, the LSI may be destroyed.

Using the ESI within electrical characteristics is strongly recommended for normal operation.

Use beyond the electric characteristics conditions will cause malfunction and poor reliability.

Note 2) All voltage values are specified as Vss = 0 V

Note 3) The relation : VDD≧Vc:>Vs≧VSOUT , Vss=OV must be maintained.

Note 4) Decoupling capacitor(Co) should be connected between Voi and Vas due to stabilized operation for the voltage doubler.

■ ELECTRICAL CHARACTERISTICS

(V_{DD}=5V±10% , Ta=-20 ~ +75℃)

PARA	MET	ΕŔ	SYMBOL	CONDITIONS M		MIN	TYP	MAX	UNIT	NOTE
Operating	Volta	ge	Voo				5.0	5.5	٧	
			Vіні	All Input and Input/Output 2		2.3		V _{DD}		
		1		Terminals exc	ept OSC				:	5
Input Voltage		VILL	Terminals				0.8	V		
THPUL YOU	Lage	2	V _{1H2}	Anty ASC Torm	Inty OSC Terminal			Voo	١ ١	
	_	<u> </u>	Airs	• • • • • • • • • • • • • • • • • • • •			<u> </u>	1.0		
		1	Vo#1	Input/Output	-1он=0.205mA	2.4				
Output Vo	l taga	'	Voli	Terminals	los=1.6mA			0.4	v	
Output 10	Lase	2	Von2	Output	-1он=0.04пА	0.9VpD			'	
			Vol2	Terminals	lot=0.04mA			0.1V _{DD}		
Driver On		- ,	Rcом	土1d=0.05mA(A				20	kΩ	6
Driver On	-resis	t.(SEG)	RSEG	±ld=0.05mA(All seg.term.)				30	1,36	ľ
Input Lea	Input Leakage Current		Lī	V1N=0 ~ VDD		- 1		1	uA I	7
Pull-up R	lesist (Current	- _P	V _{DD} =5V, RS, R/W, DB		50	125	250		
Operating	Curre	nt	l pp	V _{DD} =5V, CR Oscillator			1.9	3.3	mΑ	8
	Outpu	t	Vup	V et= 5V , loυτ=	1mA Ta=25℃	-4.6	-4.8		γ :	9
Voltage		Vol tage		V _{БООТ}						
Doubler		Effici.	Ver	Rizoo		95	99.9		X	
Domples	Input	Voltage	Aei	<u> </u>				5.5	٧	
Built-in			Rı	Ta=25℃			1.00			
		*****	R ₂				1.00			
Bleeder resistance (For LCD Driving Voltage) R3 R4 R5		Rз				2.70		kΩ		
		R ₄				1.00				
					1.00					
Oscillati	on Fre	quency	fosc	Vpp=5V, Ta=25	ొ	190	290	350	kHz	10
LCD Drivi	ng Vol	tage	VLCD	V _{DD} - V ₅ 1/5	, 1/6.7 Bias	Vpp -3.0		V _{DD} -13.5	٧	11



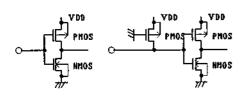
■ ELECTRICAL CHARACTERISTICS

(V_{DD} =3V±20% , T_a =-20 ~ +75 $^{\circ}$ C)

PARA	MET	ΕŔ	SYMBOL	CONDI	TIONS	MIN	TYP	MAX	UNIT	NOTÉ
Operating	Volta	ge	VDD	•		2.4	3.0	3.6	٧	
Input Voltage 1		V1H1	All Input and Input/Output Terminals except OSC		0.8Vpp		Vad	٧	ب	
iliput voi	tage	'	VILL	Terminals exc				0.2Vpd	Ċ	
	_	1	V он1	Input/Output	- он=0.205mA	2.0		<u></u>		
Dodania Na	14	'	Vol1	Terminals	low=1.6mA			0.5	ν	
Output Vo	i tage	2	V _{OH2}	Output	-lон=0.04mA	0.9Уьь		_]	
		۷ :	Vol2	Terminals	lou=0.04mA			0.1Vpp		
Driver On	-resis	t.(COM)	Rcom	±1d=0.05mA(A	[] com.term.)			20	kΩ	6
Driver On	-resis	t.(SEG)	Rsec	±1d=0.05mA(A	ll seg.term.)			30	K75	Ľ
Input Lea	Input Leakage Current LI VIN=0 ~ VDD			- 1		1	uΑ	7		
Pull-up Resist Current		- P	VDD=3V, RS, R/W, DB		10	25	50	un		
Operating	Curre	nt	ממ	Vpp=3V, CR Oscillator			1.1	1.8	mA	8
	Outpu	t	Vup	Vc:=3V, lour=	1mA Ta=25℃	-2.5	-2.75		٧	9
v		Vol tage		У 500Т						
Voltage	Conv.	Effici.	Ver	R₁≂∞		95	99.9		%	
Doubler	Input	Voltage	V _G i			1.8		VDD	٧	
D! 4			Rı	Ta=25℃		İ	1.00]	
Built-in	:	-4	R ₂	1			1.00]	
		stance	Rз	1			2.70		kΩ	
(For LCD Driving Voltage)		R ₄	1			1.00				
		R ₅	1			1.00				
Oscillati	on Fre	quency	fosc	Vыь=3VТа=25	C	160	260	320	kHz	10
LCD Drivi			Arca	Vop - Vs 1/5	, 1/6.7 Bias	V _{DD} -3.0		V _{DD} -12.0	٧	11

Note 5) Input/Output structure except LCD driver are shown below:

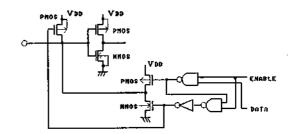
Input Terminal Structure



E Terminal

RS.R/W Terminals



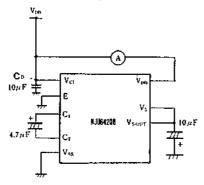


DBo to DB7 Terminals

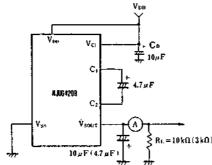


- Note 6) R_{COM} and R_{SEG} are the resistance values between power supply terminals(V_{DD} , V_1 , V_4 , V_5) and each common terminal(CDM_1 to CDM_{32}), and supply voltage (V_{DD} , V_2 , V_3 , V_5) and each segment terminal(SEG_1 to SEG_{40}) respectively, and measured when the current 1d is flown on every common and segment terminals at a same time.
- Note 7) Except pull-up resistance current and output driver current.
- Note 8) Except input/output current but including the current flow on bleeder resistance.

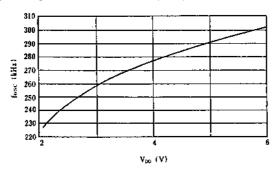
 If the input level is medium, current consumption will increase due to the penetration current. Therefore, the input level must be fixed to "H" or "L".



Note 9) Voltage Doubler Characteristics Measuring Circuit.



Note 10) Supply Voltage vs Oscillation Frequency



Note 11) Apply to the output voltage from each COM and SEG are less than ± 0.15 V against the LCD driving constant voltage (V_{DD} , V_1 , V_2 , V_3 , V_4 , V_5) at no load condition.



· Bus timing characteristics

Write operation (Write from MPU to NJU6420B)

 $(y_{DD} = 5.00 \pm 10 \text{X}, V_{SS} = 0 \text{V}, Ta = -20 \sim +75 \text{C})$

PARAMETE	R	SYMBOL	MIN	MAX	CONDITION	UNIT
Enable Cycle Time		torce	500			
Enable Pulse Width	"High" level	Pwen	220			l
Enable Rise Time, Fa	il Time	ter, ter		20	}	
Set up Time	RS, R/W, E	tas	40		fig.1	ns
Address Hold Time		t _{AH}	10	Ī	j	
Data Set up Time		tosw	60			
Data Hold Time		tн	10			

Write operation (Write from MPU to NJU64208)

 $(V_{DD} = 3.0V \pm 20X, V_{SS} = 0V, Ta = -20 \sim +75^{\circ}C)$

PARAMETE	R	SYMBOL	MIN	MAX	CONDITION	UNIT
Enable Cycle Time		†cyce	1.4			μs
Enable Pulse Width '	"High" level	Pwen	500		1	
Enable Rise Time, Fa	ll Time	ter, ter		20		
Set up Time	RS. R/W, E	tas	70		fig.1	ns
Address Hold Time		tan	10			
Data Set up Time		tosw	140			
Data Hold Time		tя	10			

Timing Characteristics (Write operation)

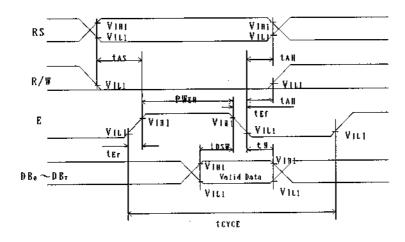


fig. 1 The timing characteristics of the bus write operating sequence.
(Write from MPU to NJU6420B)



Read operation (Read from NJU6420B to MPU)

 $(V_{DD} = 5.0V \pm 10X, V_{SS} = 0V, Ta = -20 \sim +75 ^{\circ}C)$

PARAMETER		SYMBOL	MIN	MAX	CONDITION	UNIT
Enable Cycle Time		tayas	500	<u> </u>		
Enable Pulse Width "H	igh" level	Pwen	220			
Enable Rise Time, Fall	Time	ter, ter		20		
Set up Time RS	, R/W, E	tas	40		fig.2	ns
Address Hold Time		t _{AH}	10			1
Data Delay Time		toow		120		ŀ
Data Hold Time		toon	20		<u> </u>	<u> </u>

Read operation (Read from NJU6420B to MPU)

 $(V_{DD} = 3.0V \pm 20X, V_{SB} = 0V, Ta = -20 \sim +75^{\circ}C)$

PARAMETER	SY	MBOL MI	XAK N	CONDITION	UNIT
Enable Cycle Time	to	vce 1.	4		μs
Enable Pulse Width "High"	level Pw	_{тен} 50-	0		
Enable Rise Time, Fall Time		, ter	20		
Set up Time RS, R/	H, E t,	,s 4	0	fig.2	ns
Address Hold Time	t,	.н 7	0		
Data Delay Time	te	DW	600		İ
Data Hold Time	te	он 2	0	<u> </u>	

Load Condition of DBo to DBy : CL=100pF

Timing Characteristics (Read operation)

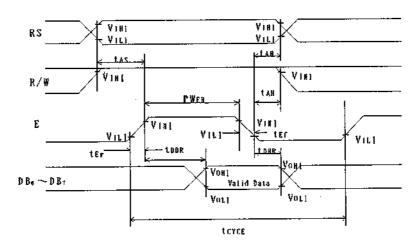


fig. 2 The timing characteristics of the bus read operating sequence.
(Read from NJU6420B to MPU)



•Power Supply Condition when using the internal initialization circuit ($V_{DD}=5.0V\pm10X$, $V_{BS}=0V$, $Ta=-20\sim+75^{\circ}C$)

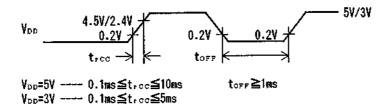
PARAMETER	SYMBOL	MIN	TYP	MAX	CONDITION	UNIT
Power Supply Rise Time	tres	0.1	-	10		
Power Supply OFF Time	toff	1	-			ms

• Power Supply Condition when using the internal initialization circuit (V_{DD} = 3.0V±20X, V_{SS} = 0V, T_a = -20 \sim +75°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	CONDITION	UNIT
Power Supply Rise Time	tree	0.1	-	5		mć.
Power Supply OFF Time	torr	1	_			₩S

Since the internal initialization circuits will not operate normally unless the above conditions are met, in such a case it must initialize by instruction.

(Refer to initialization by the instruction)

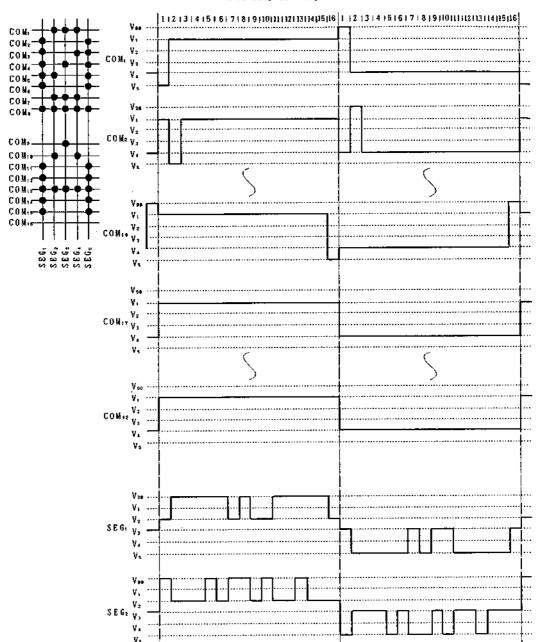


topp specifies power off time in a short period off or cyclical on/off.



III LCD DRIVING WAVEFORM

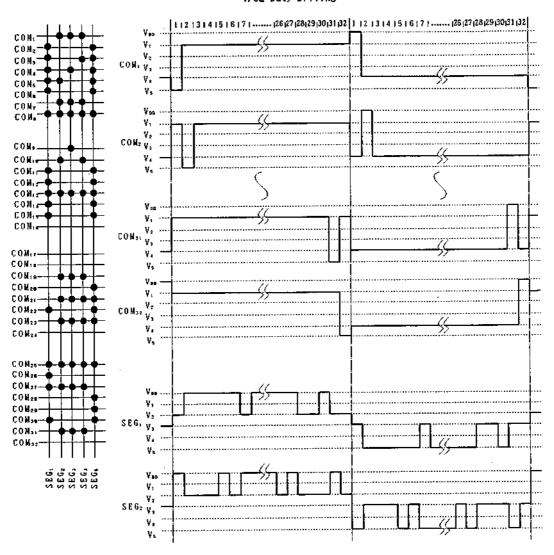
1/16 Duty Driving





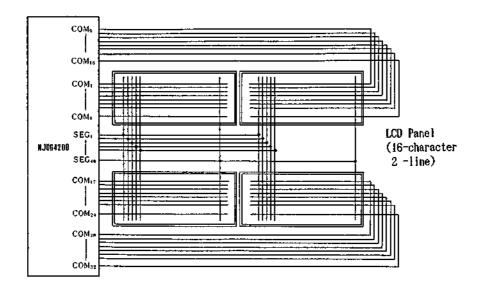
LCD DRIVING WAVEFORM

1/32 Duty Driving

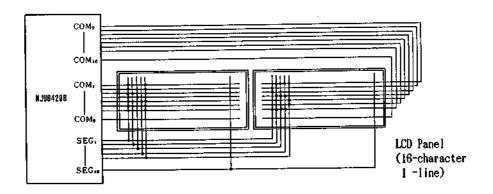




■ APPLICATION CIRCUITS

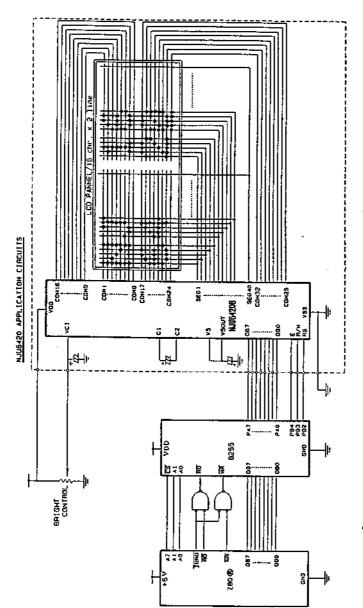


(a) 5 x 7 dots, 16-character 2-line display example (1/6.7 Bias, 1/32 Duty)



(b) 5×7 dots, 16-character 1-line display example (1/5 Bias, 1/16 Duty)

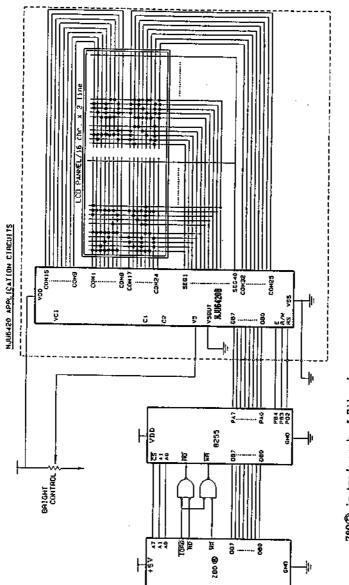




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(C) 8 bit MPU interface example (Single power supply operation, LCD driving voltage is generated by NJU64208)





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(D) 8 bit MPU interface example (Dual power supply operation. LCD driving voltage is supplied from external power supply)

NJU6420B

MEMO

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